

HSF

NOTES:

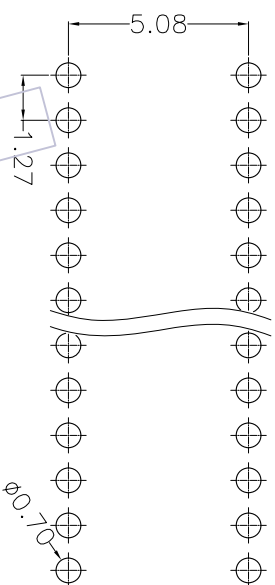
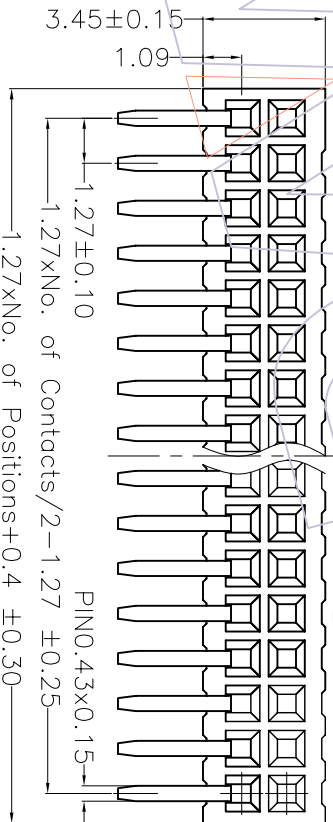
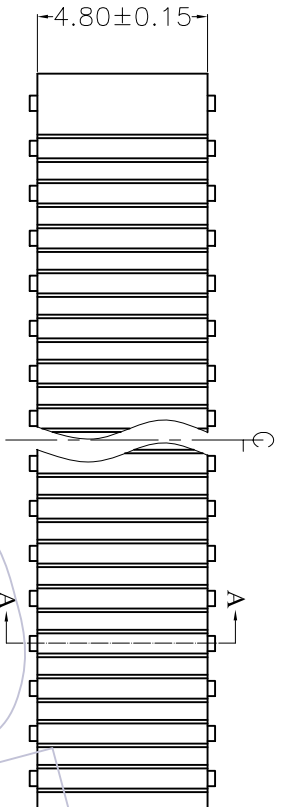
Current Rating: 1.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩMin
 Operation Temperature: -40°C to +105°C
 Contact Material: Phosphor Bronze
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T+30%G, F UL94V-0

Ordering Information

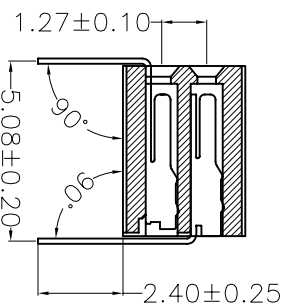
2335 - 2 XX R XX CUNT 1

No. of Pins per ROW: 02-50PIN
 Contact Plating: G=Gold Flash
 G1=5μ"Gold
 G2=5μ"Gold
 G3=10μ"Gold
 G4=15μ"Gold
 G=30μ"Gold
 S=gold Flash/Tin
 S1=5μ"Gold/Tin
 S2=5μ"Gold/Tin
 S3=10μ"Gold/Tin
 S4=15μ"Gold/Tin
 S5=30μ"Gold/Tin
 SN=Tin

Packing:
 T=Tube
 R=Reel
 P=Tube+CAP



Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	UNIT	PART NO.	TITLE:
A0	08/02/14	NEW			XX ±0.40	DESIGN	3:1	mm	2335-2XXRXXCUNT1	PH. 27 DUAL SIDE INSERT 90° H=3.45
					X.XX ±0.25	CHECK	A4	1/1		
					X.XXX ±0.15					
					Angle ± 3°					
					DIM	PROJ.				

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